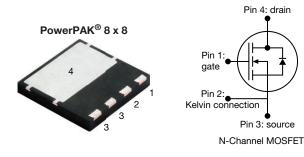
Vishay Siliconix

EF Series Power MOSFET With Fast Body Diode



www.vishay.com

| PRODUCT SUMMARY | | | | | | |
|--|------------------------------|--|--|--|--|--|
| V _{DS} (V) at T _J max. | 650 | | | | | |
| R _{DS(on)} typ. (Ω) at 25 °C | V _{GS} = 10 V 0.091 | | | | | |
| Q _g max. (nC) | 50 | | | | | |
| Q _{gs} (nC) | 16 | | | | | |
| Q _{gd} (nC) | 8 | | | | | |
| Configuration | Single | | | | | |

FEATURES

- 4th generation E series technology
- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (Co(er))
- Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- · Kelvin connection for reduced gate noise
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Solar (PV inverters)

| ORDERING INFORMATION | |
|---------------------------------|--------------------|
| Package | PowerPAK 8 x 8 |
| Lead (Pb)-free and halogen-free | SIHH105N60EF-T1GE3 |

| ABSOLUTE MAXIMUM RATINGS | $(T_C = 25 \ ^{\circ}C, \text{ unless otherwise})$ | erwise noted) | | |
|--|--|-----------------------------------|-------------|------|
| PARAMETER | | | LIMIT | UNIT |
| Drain-source voltage | V _{DS} | 600 | V | |
| Gate-source voltage | V _{GS} | ± 30 | v | |
| Continuous drain current (T _J = 150 °C) | V_{GS} at 10 V $\frac{T_{C} = 25}{T_{C} = 100}$ | °C | 26 | |
| | $T_{\rm C} = 100$ | °C | 17 | А |
| Pulsed drain current ^a | I _{DM} | 59 | | |
| Linear derating factor | | | 1.38 | W/°C |
| Single pulse avalanche energy ^b | | E _{AS} | 127 | mJ |
| Maximum power dissipation | PD | 174 | W | |
| Operating junction and storage temperature ra | nge | T _J , T _{stg} | -55 to +150 | °C |
| Drain-source voltage slope | °C dv/dt | 100 | V/ns | |
| Reverse diode dv/dt ^c | uv/ui | 50 | V/115 | |

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

- b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 3.0 A
- c. $I_{SD} \leq I_D, \, di/dt$ = 120 A/µs, starting T_J = 25 $^\circ C$



COMPLIANT

HALOGEN

FREE GREEN

(5-2008)



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| THERMAL RESISTANCE RATINGS | | | | | | |
|----------------------------------|-------------------|------|------|------|--|--|
| PARAMETER | SYMBOL | TYP. | MAX. | UNIT | | |
| Maximum junction-to-ambient | R _{thJA} | 40 | 42 | °C/W | | |
| Maximum junction-to-case (drain) | R _{thJC} | 0.55 | 0.72 | C/W | | |

| PARAMETER | SYMBOL | TEST CONDITIONS | | MIN. | TYP. | MAX. | UNIT |
|---|-----------------------|--|--|------|-------|-------|------|
| Static | | | | • | | • | |
| Drain-source breakdown voltage | V _{DS} | V _{GS} = | = 0 V, I _D = 250 μA | 600 | - | - | V |
| V _{DS} temperature coefficient | $\Delta V_{DS}/T_{J}$ | Referenc | e to 25 °C, I _D = 1 mA | - | 0.62 | - | V/°C |
| Gate-source threshold voltage (N) | V _{GS(th)} | V _{DS} = | = V _{GS} , I _D = 250 μΑ | 3.0 | - | 5.0 | V |
| | 1 | $V_{GS} = \pm 20 V$ | | - | - | ± 100 | nA |
| Gate-source leakage | I _{GSS} | , | V _{GS} = ± 30 V | - | - | ± 1 | uA |
| Zava anto valtaga duoin ovument | | V _{DS} = | = 480 V, V _{GS} = 0 V | - | - | 1 | μΑ |
| Zero gate voltage drain current | IDSS | V _{DS} = 480 V | ′, V _{GS} = 0 V, T _J = 125 °C | - | - | 2 | mA |
| Drain-source on-state resistance | R _{DS(on)} | $V_{GS} = 10 V$ | I _D = 13 A | - | 0.091 | 0.105 | Ω |
| Forward transconductance ^a | 9 _{fs} | V _{DS} | = 10 V, I _D = 13 A | - | 13 | - | S |
| Dynamic | | | | | | | |
| Input capacitance | C _{iss} | | $V_{GS} = 0 V$, | - | 2099 | - | - |
| Output capacitance | C _{oss} | , | $V_{\rm DS} = 100 \rm V,$ | - | 87 | - | |
| Reverse transfer capacitance | C _{rss} | | f = 1 MHz | - | 5 | - | |
| Effective output capacitance, energy related ^a | $C_{o(er)}$ | V_{DS} = 0 V to 480 V, V_{GS} = 0 V | | - | 65 | - | pF |
| Effective output capacitance, time related ^b | C _{o(tr)} | | | - | 408 | - | |
| Total gate charge | Qg | | | | 33 | 50 | |
| Gate-source charge | Q _{gs} | $V_{GS} = 10 \text{ V}$ $I_D = 13 \text{ A}, V_{DS} = 480 \text{ V}$ | | - | 16 | - | nC |
| Gate-drain charge | Q _{gd} | | | - | 8 | - | |
| Turn-on delay time | t _{d(on)} | | | - | 31 | 62 | |
| Rise time | t _r | V _{DD} = 480 V, I _D = 13 A, | | - | 62 | 93 | 1 |
| Turn-off delay time | t _{d(off)} | V _{GS} = | = 10 V, R_g = 9.1 Ω | - | 38 | 76 | ns |
| Fall time | t _f | | | | 28 | 56 | 1 |
| Gate input resistance | Rg | | f = 1 MHz | | 0.7 | 1.4 | Ω |
| Drain-Source Body Diode Characteristic | s | | | | | | |
| Continuous source-drain diode current | I _S | showing the | MOSFET symbol showing the | | - | 26 | |
| Pulsed diode forward current | I _{SM} | p - n junction diode | | - | - | 59 | A |
| Diode forward voltage | V _{SD} | T _J = 25 °C | T _J = 25 °C, I _S = 13 A, V _{GS} = 0 V | | - | 1.2 | V |
| Reverse recovery time | t _{rr} | | T _J = 25 °C, I _F = I _S = 13 A, | | 126 | 252 | ns |
| Reverse recovery charge | Q _{rr} | | | | 0.6 | 1.2 | μC |
| Reverse recovery current | I _{BBM} | di/dt = 100 A/µs, V _R = 25 V | | - | 9.4 | - | A |

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

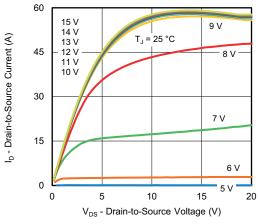


Fig. 1 - Typical Output Characteristics

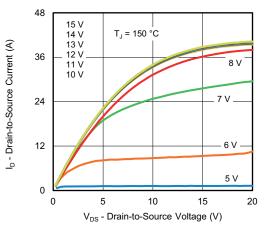


Fig. 2 - Typical Output Characteristics

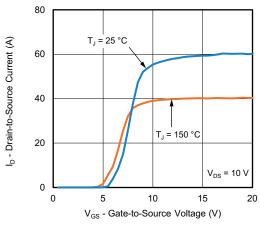


Fig. 3 - Typical Transfer Characteristics

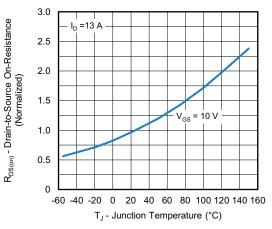


Fig. 4 - Normalized On-Resistance vs. Temperature

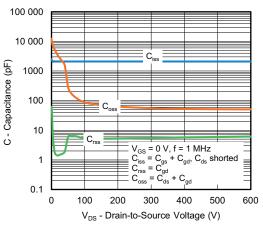
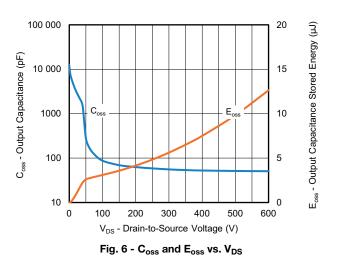


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage



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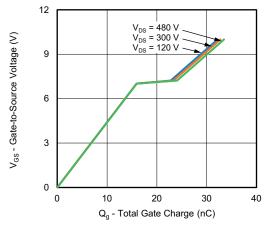


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

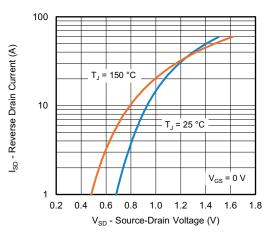


Fig. 8 - Typical Source-Drain Diode Forward Voltage

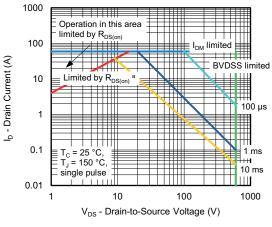


Fig. 9 - Maximum Safe Operating Area

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

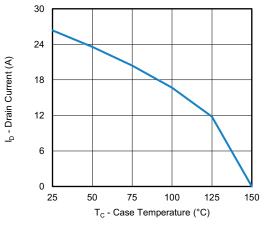


Fig. 10 - Maximum Drain Current vs. Case Temperature

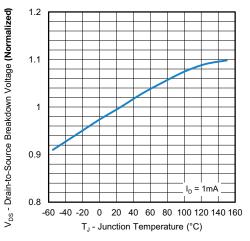
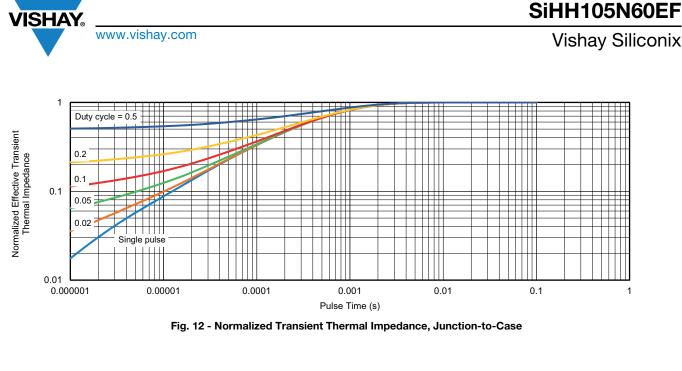


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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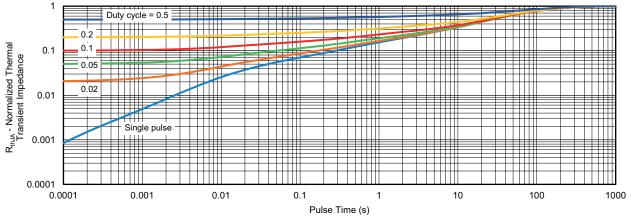


Fig. 13 - Normalized Thermal Transient Impedance, Junction-to-Ambient

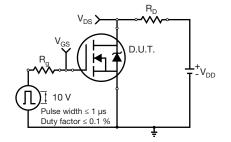


Fig. 14 - Switching Time Test Circuit

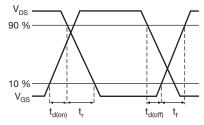


Fig. 15 - Switching Time Waveforms

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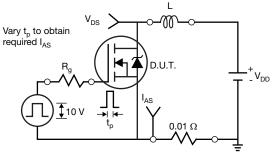


Fig. 16 - Unclamped Inductive Test Circuit

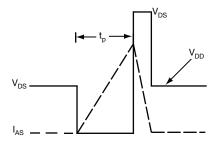


Fig. 17 - Unclamped Inductive Waveforms

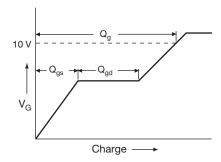


Fig. 18 - Basic Gate Charge Waveform

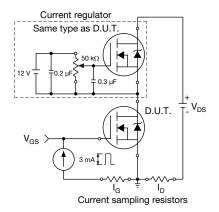


Fig. 19 - Gate Charge Test Circuit

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Peak Diode Recovery dv/dt Test Circuit

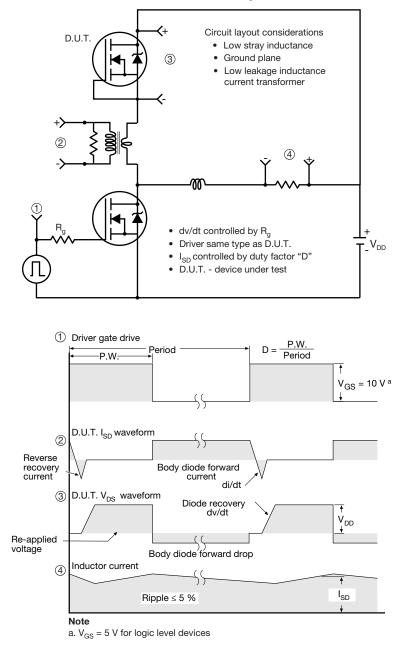


Fig. 20 - For N-Channel

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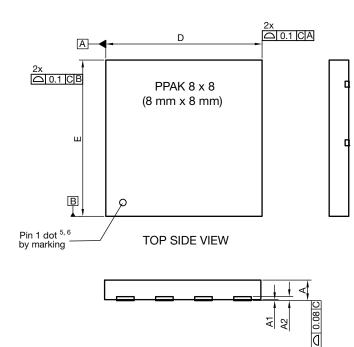
7

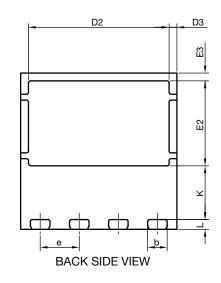
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PowerPAK[®] 8 x 8 Case Outline





| DIM | MILLIMETERS | | INCHES | | | | | |
|------------------|-------------|----------|-----------|------------|--------------------|-------|--|--|
| DIM. | MIN. | NOM. | MAX. | MIN. | NOM. | MAX. | | |
| А | 0.95 | 1.00 | 1.05 | 0.037 | 0.039 | 0.041 | | |
| A1 | 0.00 | - | 0.05 | 0.000 | - | 0.002 | | |
| A2 | 020 ref. | | | 0.008 ref. | | | | |
| b | 0.95 | 1.00 | 1.05 | 0.037 | 0.039 | 0.041 | | |
| D | 7.90 | 8.00 | 8.10 | 0.311 | 0.315 | 0.319 | | |
| D2 | 7.10 | 7.20 | 7.30 | 0.280 | 0.283 | 0.287 | | |
| D3 | 0.40 BSC | | | 0.016 BSC | | | | |
| е | 2.00 BSC | | 0.079 BSC | | | | | |
| E | 7.90 | 8.00 | 8.10 | 0.311 | 0.315 | 0.319 | | |
| E2 | 4.30 | 4.35 | 4.40 | 0.169 | 0.171 | 0.173 | | |
| E3 | | 0.40 BSC | | | 0.40 BSC 0.016 BSC | | | |
| К | 2.75 BSC | | 0.108 BSC | | | | | |
| L | 0.45 | 0.50 | 0.55 | 0.018 | 0.020 | 0.022 | | |
| N ⁽³⁾ | 8 | | | | 8 | | | |

Notes

⁽¹⁾ Use millimeters as the primary measurement

⁽²⁾ Dimensioning and tolerances conform to ASME Y14.5 M - 1994

⁽³⁾ N is the number of terminals

⁽⁴⁾ The pin 1 identifier must be existed on the top surface of the package by using indentation mark or other feature of package body

⁽⁵⁾ Exact shape and size of this feature is optional

ECN: E20-0518-Rev. B, 28-Sep-2020 DWG: 6041

Revision: 28-Sep-2020

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Recommended Minimum PADs for PowerPAK[®] 8 mm x 8 mm



Dimensions in millimeters

Document Number: 68441



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